

## **LOCTITE ECCOBOND FP4549**

January 2015

## PRODUCT DESCRIPTION

LOCTITE ECCOBOND FP4549 provides the following product characteristics:

Technology	Ероху
Appearance	White liquid
Product Benefits	High purity
	<ul> <li>Low stress</li> </ul>
	<ul> <li>Low moisture absorption</li> </ul>
	<ul> <li>Extends thermal cycling</li> </ul>
	performance
	<ul> <li>Dissipates stress on solder joints</li> </ul>
	<ul> <li>Improved JEDEC performance</li> </ul>
Cure	Heat cure
Application	Encapsulation
Typical Package	Flip chip devices
Application	

LOCTITE ECCOBOND FP4549 liquid epoxy adhesive is designed for enhanced adhesion to integrated circuit passivation materials. This material is formulated to quickly underfill devices at 90°C to 110°C with as little as a 1/2 mil gap. When fully cured, the material forms a rigid, low stress seal that dissipates stress on solder joints and extends thermal cycling performance.

## TYPICAL PROPERTIES OF UNCURED MATERIAL

Viscosity, Brookfield - Cone & Plate, 25 °C, mPa·s (cP):	
Spindle 52, speed 20 rpm	2,300
Filler Content, % Ignition	50
Flow Rate @ 90 °C, 75 µm gap, 12,700 µm travel,	15
seconds	
Pot Life @ 25 °C (time to double viscosity), hours	24
Gel Time @ 121°C, minutes	13.5
Shelf Life @ -40°C, days	274
Floch Boint Soc SDS	

Flash Point - See SDS

#### TYPICAL CURING PERFORMANCE

## **Recommended Cure Schedule**

30 minutes @ 165°C

The above cure profile is a guideline recommendation. Cure conditions (time and temperature) may vary based on customers' experience and their application requirements, as well as customer curing equipment, oven loading and actual oven temperatures.

## TYPICAL PROPERTIES OF CURED MATERIAL

## **Physical Properties**

Coefficient of Linear Thermal Expansion, Sample	cured 7 min @
160°C:	_
Below Tg, ppm/°C	45
Above Tg, ppm/°C	143
Glass Transition Temperature (Tg) by TMA, °C	140

Flexural Modulus	N/mm² (psi)	5,600 (812,000)
Extractable Ionic Content, ppm:		
Chloride (Cl-)		3
Sodium (Na+)		2

## TYPICAL PERFORMANCE OF CURED MATERIAL

#### **Adhesive Properties**

Die Shear Strength, Kg: Nitride Passivated/FR4 substrate: 100 mil x 100 mil die @ 25°C

50±2

#### **GENERAL INFORMATION**

For safe handling information on this product, consult the Safety Data Sheet, (SDS).

#### Not for product specifications

The technical data contained herein are intended as reference only. Please contact your local quality department for assistance and recommendations on specifications for this product.

## **THAWING:**

- 1. Allow container to reach room temperature before use.
- Store tip down and warm at room temperature until no longer cool to the touch (normally 60 to 90 minutes).
- 3. DO NOT thaw in an oven.

## Directions for use

- 1. For best flow rates, a preheat temperature of 90  $^{\circ}\text{C}$  is recommended.
- 2. For best results in dispensing a 22 gauge needle should be used at 10 to 20 psi pressure.

#### STORAGE:

Store product in the unopened container in a dry location. Storage information may be indicated on the product container labeling.

#### Optimal Storage: -40 °C

Material removed from containers may be contaminated during use. Do not return product to the original container. Henkel Corporation cannot assume responsibility for product which has been contaminated or stored under conditions other than those previously indicated. If additional information is required, please contact your local Technical Service Center or Customer Service Representative.



Conversions

(°C x 1.8) + 32 = °F kV/mm x 25.4 = V/mil mm / 25.4 = inches N x 0.225 = lb N/mm x 5.71 = lb/in psi x 145 = N/mm² MPa = N/mm² N·m x 8.851 = lb·in N·m x 0.738 = lb·ft N·mm x 0.142 = oz·in mPa·s = cP

## Disclaimer

#### Note

The information provided in this Technical Data Sheet (TDS) including the recommendations for use and application of the product are based on our knowledge and experience of the product as at the date of this TDS. The product can have a variety of different applications as well as differing application and working conditions in your environment that are beyond our control. Henkel is, therefore, not liable for the suitability of our product for the production processes and conditions in respect of which you use them, as well as the intended applications and results. We strongly recommend that you carry out your own prior trials to confirm such suitability of our product.

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Reference 1

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